COMPLIANT

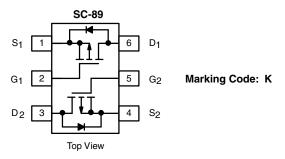
HALOGEN

FREE



P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (mA)		
	8 at V _{GS} = - 4.5 V	- 150		
- 20	12 at V _{GS} = - 2.5 V	- 125		
- 20	15 at V _{GS} = - 1.8 V	- 100		
	20 at V _{GS} = - 1.5 V	- 30		



Ordering Information: Si1033X-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET: 1.5 V Rated
- High-Side Switching
 Low On-Resistance: 8 Ω
 Low Threshold: 0.9 V (typ.)
- Fast Switching Speed: 45 ns (typ.)
- 1.5 V Operation
- Gate-Source ESD Protected: 2000 V
 Compliant to RoHS Directive 2002/95/EC

BENEFITS

- · Ease in Driving Switches
- · Low Offset (Error) Voltage
- · Low-Voltage Operation
- · High-Speed Circuits
- Low Battery Voltage Operation

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- · Battery Operated Systems
- · Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
Parameter	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage		V _{GS}	± 5		
Continuous Dunin Courset /T 150 00\d	T _A = 25 °C	I _D	- 155	- 145	^
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 110	- 105	
Pulsed Drain Current ^b		I _{DM}	- 650		mA
Continuous Source Current (Diode Conduction) ^a		I _S	- 450	- 380	
M	T _A = 25 °C	P _D	280	250	mW
Maximum Power Dissipation ^a	T _A = 85 °C		145	130	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000		V

Notes

- a. Surface mounted on FR4 board.
- b. Pulse width limited by maximum junction temperature.

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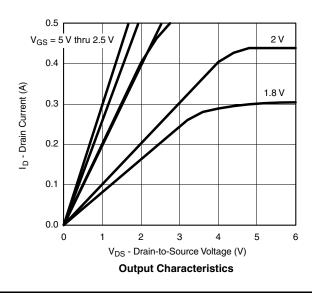
SPECIFICATIONS (T _A = 25 °C, unl		Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static	Syllibol	rest conditions	IVIIII.	Typ.	IVIAX.	Onit	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	- 0.40		- 1.20	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 2.8 \text{ V}$ ± 0.5		± 0.5	± 1		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$		± 1	± 2	μΑ	
7 0		V _{DS} = - 16 V, V _{GS} = 0 V		- 1	- 500	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 16 V, V _{GS} = 0 V, T _J = 85 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 200			mA	
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 150 mA			8		
	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 125 mA	12		0		
		V _{GS} = - 1.8 V, I _D = - 100 mA			15	Ω	
		V _{GS} = - 1.5 V, I _D = - 30 mA			20		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 150 mA		0.4		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 150 mA, V _{GS} = 0 V			- 1.2	V	
Dynamic ^b							
Total Gate Charge	Qg			1500			
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -150 \text{ mA}$		150		рС	
Gate-Drain Charge	Q_{gd}			450			
Turn-On Delay Time	t _{d(on)}				55		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 65 Ω			30	ne	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 150 mA, V_{GEN} = - 4.5 V, R_g = 10 Ω			60	ns	
Fall Time	t _f				30		

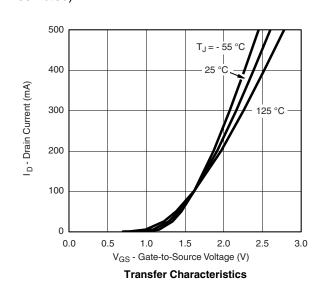
Notes:

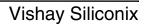
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

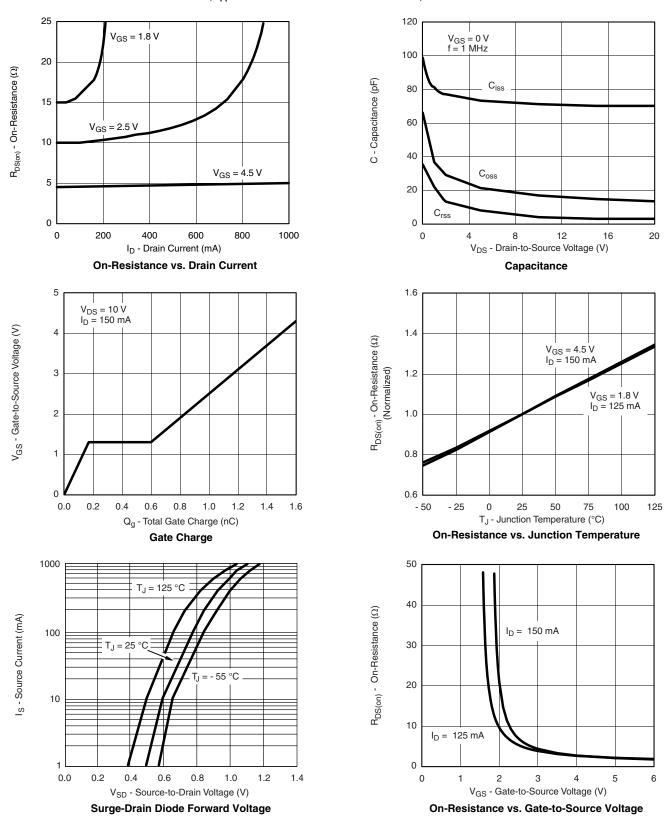








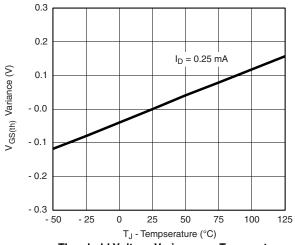
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

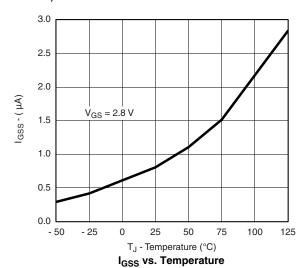


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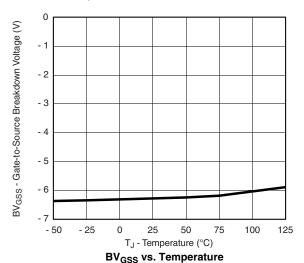


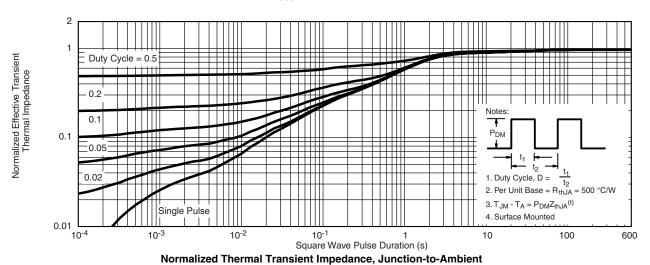
TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted)





Threshold Voltage Variance vs. Temperature

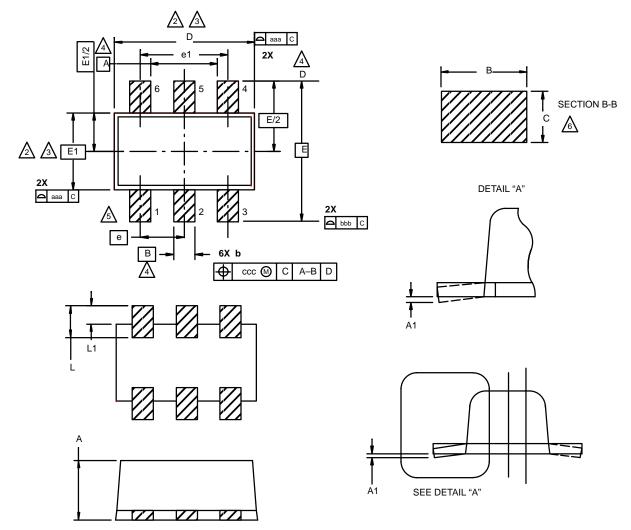




Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71428.



SC89: 6- LEADS (SOT-563F)



NOTES:

1. Dimensions in millimeters.



Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.



Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.



Datums A, B and D to be determined 0.10 mm from the lead tip.



Terminal numbers are shown for reference only.



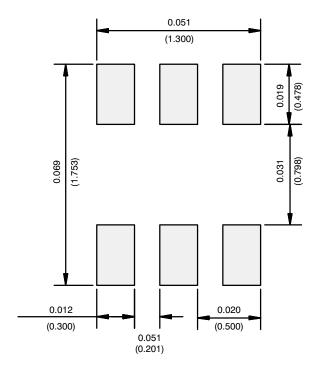
These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

	MILLIM	IETERS			Tolerances Of Form And	
Dim	Min	Max	Note	Symbol	Position	
Α	0.56	0.60		aaa	0.10	
A1	0.00	0.10		bbb	0.10	
b	0.15	0.30		ccc	0.10	
С	0.10	0.18				
D	1.50	1.70	2, 3			
E	1.55	1.70				
E1	1.20 BSC		2, 3			
е	0.50 BSC					
e1	1.00 BSC					
L	0.35 BSC					
L1	0.20 BSC					
ECN: E-00499—Rev. B, 02-Jul-01						

DWG: 5880



RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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Revision: 02-Oct-12 Document Number: 91000

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